ZrO₂ - based powders Phase transitions





Phases diagram P-T of ZrO₂ versus crystallite size deduced from Raman P-T and XRD measurements

Effect of crystallite size = Effect of internal pressure + entropic contribution



P. Bouvier, E. Djurado, G. Lucazeau, T. le Bihan, *Phys. Rev. B* 62 (13) (2000) 8731

P. Bouvier, E. Djurado, C. Ritter, A. J. Dianoux and G. Lucazeau, Int. J. of Inorg. Mat. 3 [7] (2001) 647





- » Ultrasonic Spray Pyrolysis (USP) process DOE
- » ZrO₂ based powders: morphology and phase transitions
- » Physico-chemical properties of CGO powders and sintering behavior
- » USP advantages and disadvantages

2 – Electrostatic Spray Deposition for the design of dense and porous films

» Electrostatic Spray Deposition (ESD) process

- » Optimization study of the ESD process to coat thin dense zirconia-based films
- » Fundamental study of the formation of the ESD layer
- » Advanced oxygen electrodes for SOC:

LSCF, CCO, LSM, LSM/YSZ, LPNO

CGO (Ce_{0.8}Gd_{0.2}O_{1.9}) SINTERING DIFFICULTIES ↓ LOW FINAL DENSITY ~92% TD → T > 1500°C¹ MICROSTRUCTURAL HETEROGENEITY²

Objectives

CONTROL POWDER MICROSTRUCTURE (USP)

1. Ruiz-Trejo, E.; Benítez-Rico, A.; Gómez-Reynoso, S.; Angeles-Rosas, M. Journal of The Electrochemical Society, 2007, 154, A258-A26218

2. Li, Z.; Mori, T.; Auchterlonie, G.J.; Zou, J.; Drennan, Journal Materials Research Bulletin 2012, 47, 763–767

CGO ($Ce_{0.8}Gd_{0.2}O_{1.9}$) - **Morphology**

T (°C)	f (kHz)	C (mol.L ⁻¹)	Q (L.min ⁻¹)	Morphology
400	2500	2.5 x 10 ⁻³	3/6	Small and dense particles with ovoid shape (a)
1000	2500	2.5 x 10 ⁻²	3/6	Porous and uneven particles (b)



Increase C (mol.l⁻¹)

 \rightarrow

Density of matter is increased

Uneven particles 19

 \rightarrow

CGO Particle size and Particle size distribution

Analysis of SEM images by ImageJ software



Narrow Distribution (CGO ND)

Large Distribution (CGO LD)

CGO Crystallite size



Cubic CGO single phase - fluorite - $Fm\overline{3}m$

PANalytical X'Pert Pro MPD diffractometer in the Bragg–Brentano geometry 20 - 135° in 20, step : 0.084°, step time : 360 s, with Cu radiation λ = 0.154056 Å



CGO Sintering behavior



C. Goulart et E. Djurado, Journal of the European Ceramic Society 33 (2013) 769–778

Smaller particles and narrower distribution → better densification at lower temperatures CGO DENSIFICATION is strongly dependent on CGO powders characteristics





- » Ultrasonic Spray Pyrolysis (USP) process DOE
- » ZrO₂ based powders: morphology and phase transitions
- » Physico-chemical properties of CGO powders and sintering behavior
- » USP advantages and disadvantages

2 – Electrostatic Spray Deposition for the design of dense and porous films

» Electrostatic Spray Deposition (ESD) process

- » Optimization study of the ESD process to coat thin dense zirconia-based films
- » Fundamental study of the formation of the ESD layer
- » Advanced oxygen electrodes for SOC:

LSCF, CCO, LSM, LSM/YSZ, LPNO

- Obtention of crystalline ceramic powders at low T
- Homogeneity in composition and particle size
- Controlled microstructure
- Excellent reproducibility
- ✓ Single-step fabrication
- Low cost method
- Low quantity of powdersPowder agglomeration





- » Ultrasonic Spray Pyrolysis (USP) process DOE
- » ZrO₂ based powders: morphology and phase transitions
- » Physico-chemical properties of CGO powders and sintering behavior
- » USP advantages and disadvantages

2 – Electrostatic Spray Deposition for the design of dense and porous films

» Electrostatic Spray Deposition (ESD) process

- » Optimization study of the ESD process to coat thin dense zirconia-based films
- » Fundamental study of the formation of the ESD layer
- » Advanced oxygen electrodes for SOC:

LSCF, CCO, LSM, LSM/YSZ, LPNO

Electrostatic Spray Deposition (ESD): from solution to ceramic to deposit nanostructured films



Spray pyrolysis process

- atomisation by pneumatic pulverisation, ultrasound or by electrostatic
- transport of the aerosol gas flow, electrical field.
- evaporation of solvent, decomposition / sublimation, chemical reaction - during transport or on the substrate
- recristallisation.

ESD : atomisation and displacement of the aerosol in the electric field applied between needle and substrate.

ESD PROCESS



٠

Vertical installation to avoid atypic droplets and solution running on the substrate

- High DC voltage between ٠ needle and substrate
- Precursors solution (precursors, solvants and additives)

ESD Principle : This process obeys to electrohydrodynamic atomisation laws of liquids to produce an aerosol from a liquid precursor in high voltage which is then directed to a heated substrate

THE FIRST STEP OF THE ESD PROCESS: ATOMISATION



When a solution is constrained to pass through a thin metal needle connected to voltage, an electrostatic field is set up across the needle and the grounded plate acting on ions in the solution. In the case of a positive potential, positive ions move to the surface of the solution. The surface charge causes an outward electrostatic pressure on the solution which is opposite to the inward directed pressure from the surface tension. This leads to surface instabilities and distorsion into a stable conical shape (Taylor cone), as electrohydrodynamic mechanisms.

THE FIRST STEP OF THE ESD PROCESS : ATOMISATION



*Ganan-Calvo- Physical Review Letters 79 (2) 1997 pp. 217-220

Ceramic

THE SECOND STEP OF THE ESD PROCESS : AEROSOL TRANSPORT



THE THIRD STEP OF THE ESD PROCESS : SPREADING, DRYING, DROPLETS DECOMPOSITION







» Ultrasonic Spray Pyrolysis (USP) process – DOE

- » ZrO₂ based powders: morphology and phase transitions
- » Physico-chemical properties of CGO powders and sintering behavior
- » USP advantages and disadvantages

2 – Electrostatic Spray Deposition for the design of dense and porous films

» Electrostatic Spray Deposition (ESD) process

» Optimization study of the ESD process to coat thin dense zirconia-based films

- » Fundamental study of the formation of the ESD layer
- » Advanced oxygen electrodes for SOC:

LSCF, CCO, LSM, LSM/YSZ, LPNO

Optimization study of the ESD process to coat <u>thin dense</u> zirconia-based films

Two directions :

- The influence of process parameters R. NEAGU and al., Solid State Ionics 177 (2006) 1981-1984
- The influence of chemical parameters
 - nature and concentration of precursors
 - nature of solvents

R. NEAGU and al., Solid State lonics 177 [17-18] (2006) 1451-1460.

Optimisation of the process parameters

- Study of the influence of process parameters
 - Substrate temperature
 - Nozzle to substrate distance
 - Solution flow rate

Experimental conditions to optimize :

- Substrate temperature: from 300° to 575°C
- Nozzle to substrate distance: from 27 to 57 mm.
- Solution flow rate: from 0.5 to 2.5 ml/h.
- Coating time : 1 h.